

# PS9505, PS9505L1, PS9505L2, PS9505L3

## Data Sheet

R08DS0015EJ0100

Rev.1.00

Jan 06, 2012

2.5 A OUTPUT CURRENT, HIGH CMR, IGBT GATE DRIVE, 8-PIN DIP PHOTOCOUPLER

### DESCRIPTION

The PS9505, PS9505L1, PS9505L2 and PS9505L3 are optically coupled isolators containing a GaAlAs LED on the input side and a photo diode, a signal processing circuit and a power output transistor on the output side on one chip.

The PS9505 Series is designed specifically for high common mode transient immunity (CMR), high output current and high switching speed.

The PS9505 Series is suitable for driving IGBTs and MOS FETs.

The PS9505 Series is in a plastic DIP (Dual In-line Package).

The PS9505L1 is lead bending type for long creepage distance.

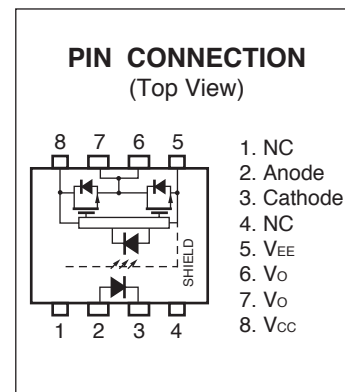
The PS9505L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

The PS9505L3 is lead bending type (Gull-wing) for surface mounting.

### FEATURES

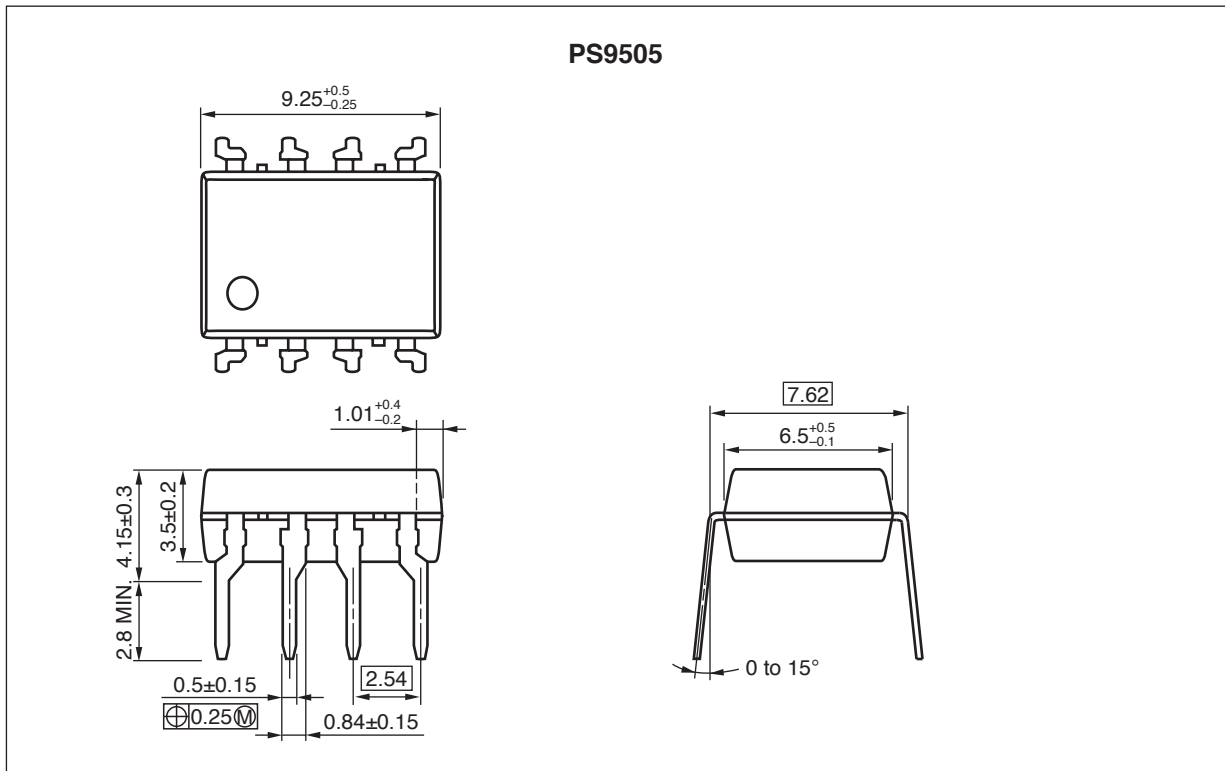
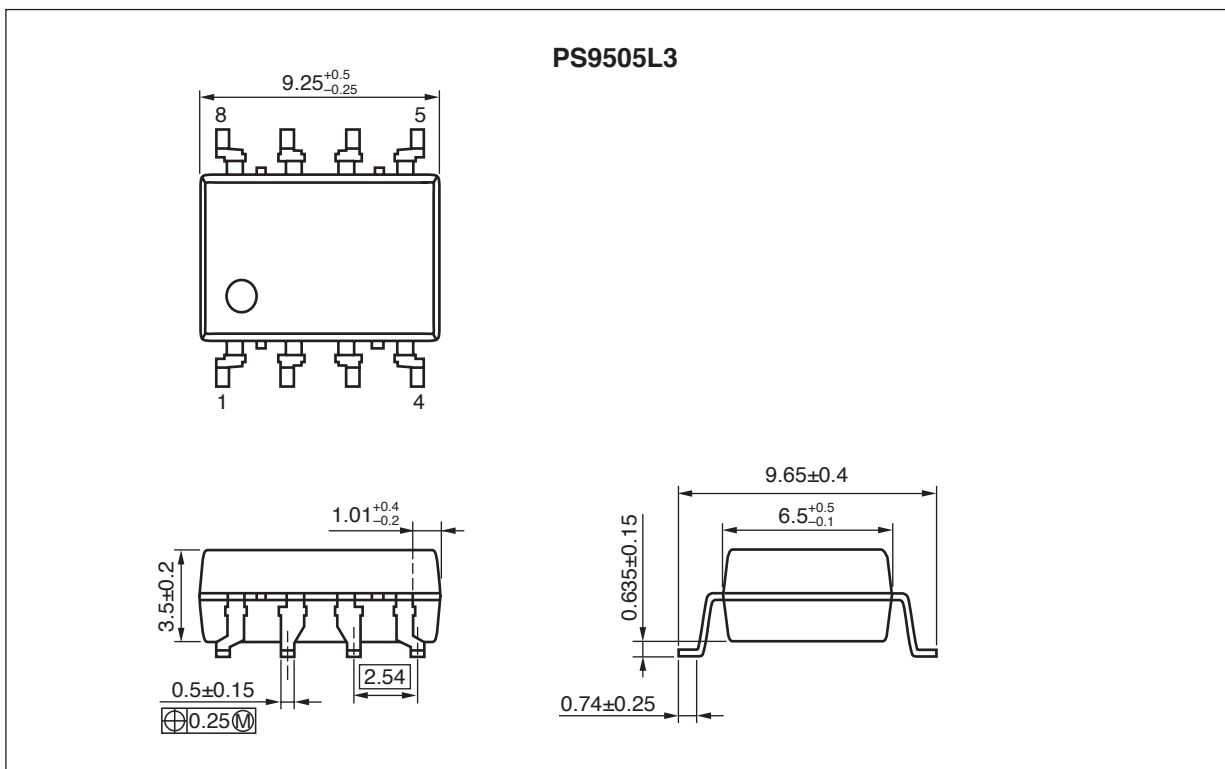
- Long creepage distance (8 mm MIN.: PS9505L1, PS9505L2)
- Large peak output current (2.5 A MAX., 2.0 A MIN.)
- High speed switching ( $t_{PLH}$ ,  $t_{PHL}$  = 0.25  $\mu$ s MAX.)
- UVLO (Under Voltage Lock Out) protection with hysteresis
- High common mode transient immunity ( $CM_H$ ,  $CM_L$  =  $\pm 25$  kV/ $\mu$ s MIN.)
- Embossed tape product: PS9505L2-E3: 1 000 pcs/reel  
: PS9505L3-E3: 1 000 pcs/reel

- <R>
- Pb-Free product
- <R>
- Safety standards
    - UL approved: No. E72422
    - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
    - SEMKO approved: No. 1115598
    - DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40024069 (Option)

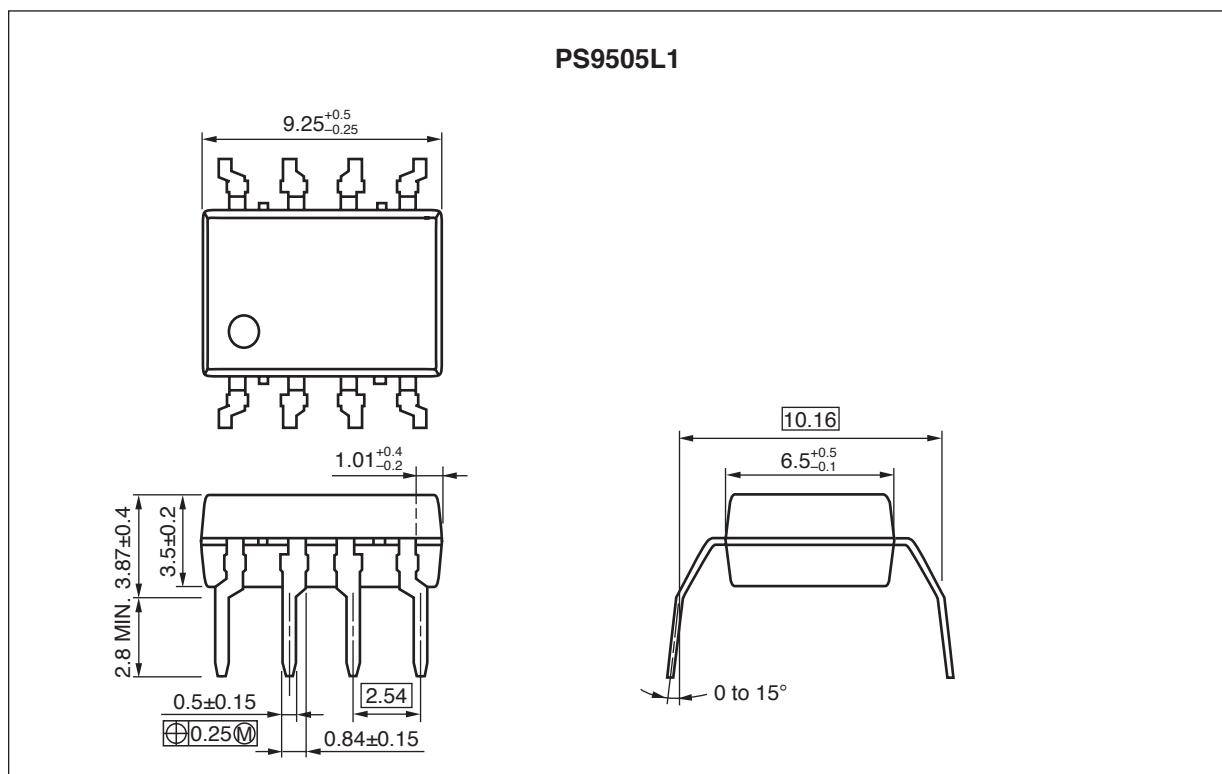


### APPLICATIONS

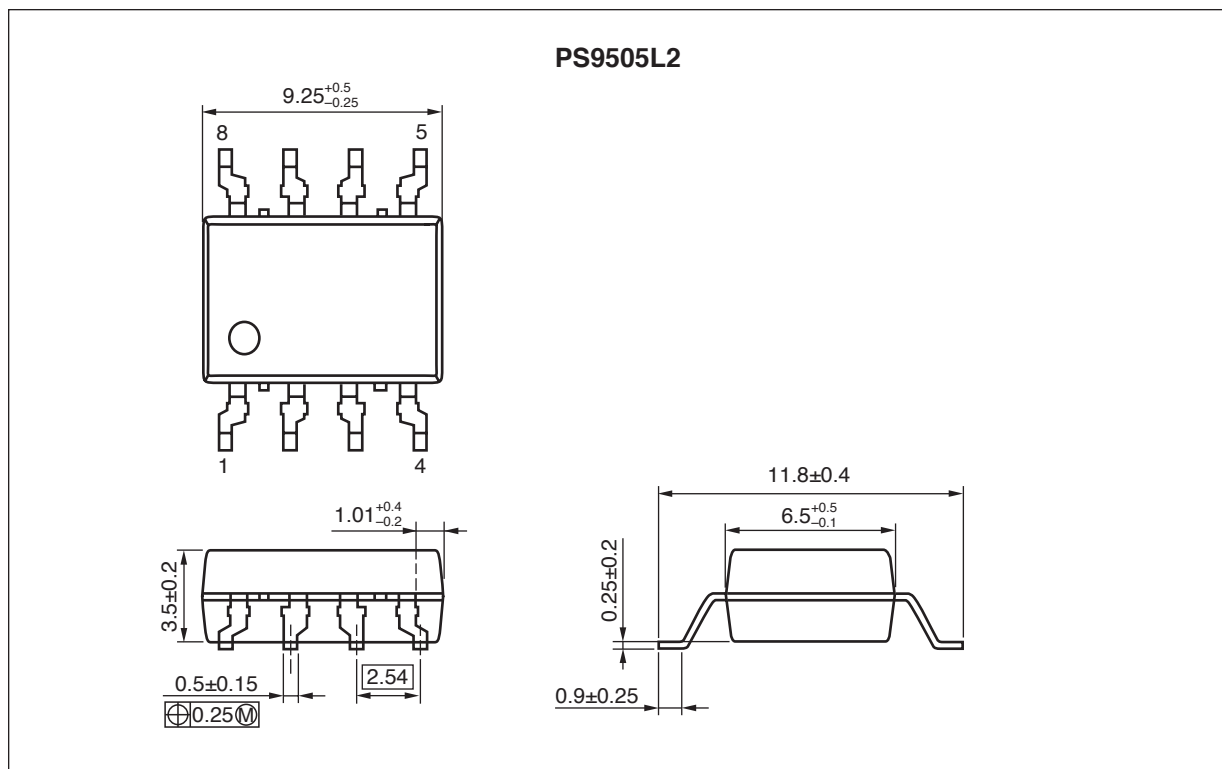
- IGBT, Power MOS FET Gate Driver
- Industrial inverter
- IH (Induction Heating)

**PS9505,PS9505L1,PS9505L2,PS9505L3**
**PACKAGE DIMENSIONS (UNIT: mm)**
**DIP Type**

**Lead Bending Type (Gull-wing) For Surface Mount**


## Lead Bending Type For Long Creepage Distance



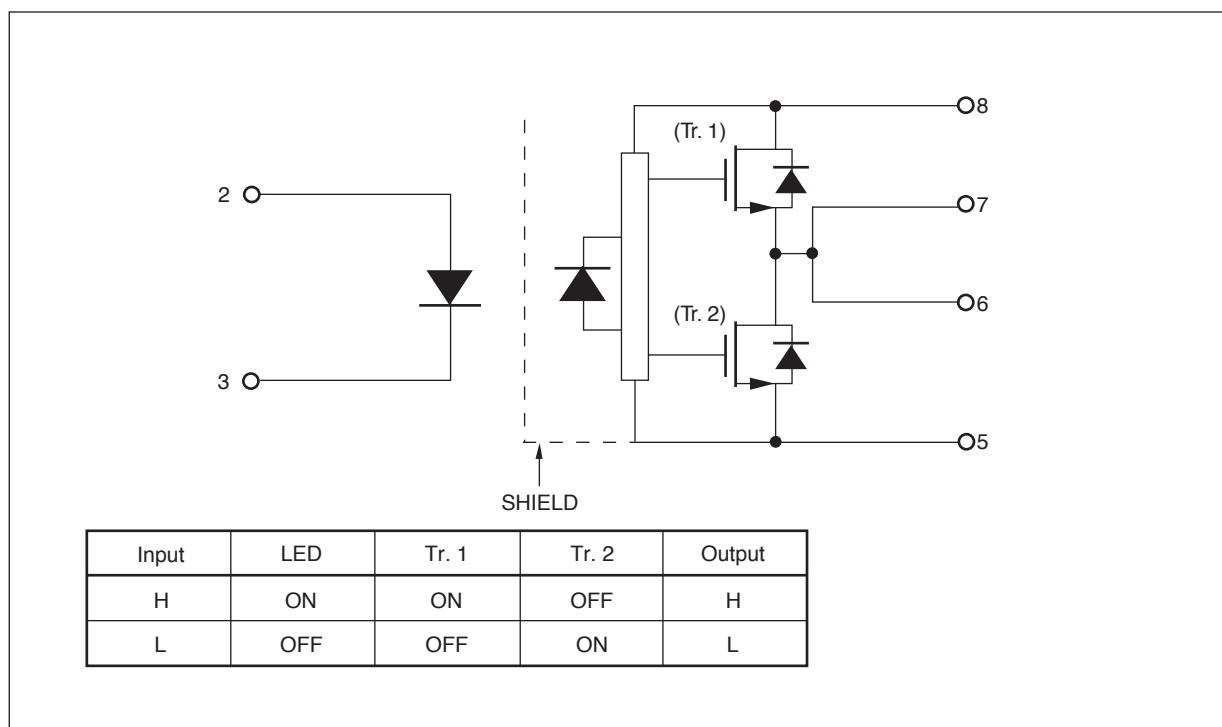
## Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)



## PHOTOCOUPLER CONSTRUCTION

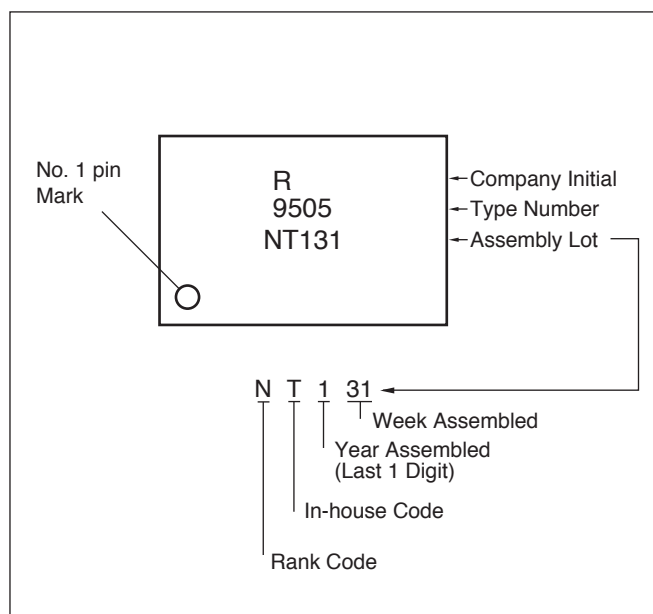
| Parameter                      | PS9505, PS9505L3 | PS9505L1, PS9505L2 |
|--------------------------------|------------------|--------------------|
| Air Distance (MIN.)            | 7 mm             | 8 mm               |
| Outer Creepage Distance (MIN.) | 7 mm             | 8 mm               |
| Isolation Distance (MIN.)      | 0.4 mm           | 0.4 mm             |

## FUNCTIONAL DIAGRAM



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## MARKING EXAMPLE



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## ORDERING INFORMATION

| Part Number   | Order Number     | Solder Plating Specification | Packing Style                   | Safety Standard Approval                                   | Application Part Number <sup>*1</sup> |
|---------------|------------------|------------------------------|---------------------------------|------------------------------------------------------------|---------------------------------------|
| PS9505        | PS9505-AX        | Pb-Free<br>(Ni/Pd/Au)        | 50 Magazine Cases               | Standard products<br>(UL, CSA, SEMKO approved)             | PS9505                                |
| PS9505L1      | PS9505L1-AX      |                              |                                 |                                                            | PS9505L1                              |
| PS9505L2      | PS9505L2-AX      |                              |                                 |                                                            | PS9505L2                              |
| PS9505L3      | PS9505L3-AX      |                              |                                 |                                                            | PS9505L3                              |
| PS9505L2-E3   | PS9505L2-E3-AX   |                              | Embossed Tape<br>1 000 pcs/reel |                                                            | PS9505L2                              |
| PS9505L3-E3   | PS9505L3-E3-AX   |                              |                                 |                                                            | PS9505L3                              |
| PS9505-V      | PS9505-V-AX      |                              | 50 Magazine Cases               | DIN EN60747-5-2<br>(VDE0884 Part2)<br>approved<br>(Option) | PS9505                                |
| PS9505L1-V    | PS9505L1-V-AX    |                              |                                 |                                                            | PS9505L1                              |
| PS9505L2-V    | PS9505L2-V-AX    |                              |                                 |                                                            | PS9505L2                              |
| PS9505L3-V    | PS9505L3-V-AX    |                              |                                 |                                                            | PS9505L3                              |
| PS9505L2-V-E3 | PS9505L2-V-E3-AX |                              | Embossed Tape<br>1 000 pcs/reel |                                                            | PS9505L2                              |
| PS9505L3-V-E3 | PS9505L3-V-E3-AX |                              |                                 |                                                            | PS9505L3                              |

\*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)

| Parameter                             |                                                     | Symbol                               | Ratings              | Unit    |
|---------------------------------------|-----------------------------------------------------|--------------------------------------|----------------------|---------|
| Diode                                 | Forward Current                                     | I <sub>F</sub>                       | 25                   | mA      |
|                                       | Peak Transient Forward Current (Pulse Width < 1 μs) | I <sub>F (TRAN)</sub>                | 1.0                  | A       |
|                                       | Reverse Voltage                                     | V <sub>R</sub>                       | 5                    | V       |
| Detector                              | High Level Peak Output Current <sup>*1</sup>        | I <sub>OH (PEAK)</sub>               | 2.5                  | A       |
|                                       | Low Level Peak Output Current <sup>*1</sup>         | I <sub>OL (PEAK)</sub>               | 2.5                  | A       |
|                                       | Supply Voltage                                      | (V <sub>CC</sub> - V <sub>EE</sub> ) | 0 to 35              | V       |
|                                       | Output Voltage                                      | V <sub>O</sub>                       | 0 to V <sub>CC</sub> | V       |
|                                       | Power Dissipation <sup>*2</sup>                     | P <sub>C</sub>                       | 250                  | mW      |
| Isolation Voltage <sup>*3</sup>       |                                                     | BV                                   | 5 000                | Vr.m.s. |
| Total Power Dissipation <sup>*4</sup> |                                                     | P <sub>T</sub>                       | 300                  | mW      |
| Operating Frequency <sup>*5</sup>     |                                                     | f                                    | 50                   | kHz     |
| Operating Ambient Temperature         |                                                     | T <sub>A</sub>                       | -40 to +110          | °C      |
| Storage Temperature                   |                                                     | T <sub>stg</sub>                     | -55 to +125          | °C      |

\*1 Maximum pulse width = 10 μs, Maximum duty cycle = 0.2%

\*2 Reduced to 4.8 mW/°C at T<sub>A</sub> = 70°C or more.

\*3 AC voltage for 1 minute at T<sub>A</sub> = 25°C, RH = 60% between input and output.  
Pins 1-4 shorted together, 5-8 shorted together.

\*4 Reduced to 5.4 mW/°C at T<sub>A</sub> = 70°C or more.

\*5 I<sub>OH (PEAK)</sub> ≤ 2.0 A (≤ 0.3 μs), I<sub>OL (PEAK)</sub> ≤ 2.0 A (≤ 0.3 μs)

## RECOMMENDED OPERATING CONDITIONS

| Parameter                     | Symbol                | MIN. | TYP. | MAX. | Unit |
|-------------------------------|-----------------------|------|------|------|------|
| Supply Voltage                | ( $V_{CC} - V_{EE}$ ) | 15   |      | 30   | V    |
| Forward Current (ON)          | $I_F$ (ON)            | 7    | 10   | 16   | mA   |
| Forward Voltage (OFF)         | $V_F$ (OFF)           | -2   |      | 0.8  | V    |
| Operating Ambient Temperature | $T_A$                 | -40  |      | 110  | °C   |

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## ELECTRICAL CHARACTERISTICS

(V<sub>EE</sub> = GND, unless otherwise specified and refer to RECOMMENDED OPERATING CONDITIONS)

| Parameter |                                             | Symbol       | Conditions                                                           | MIN.           | TYP.*1         | MAX. | Unit          |
|-----------|---------------------------------------------|--------------|----------------------------------------------------------------------|----------------|----------------|------|---------------|
| Diode     | Forward Voltage                             | $V_F$        | $I_F = 10 \text{ mA}$ , $T_A = 25^\circ\text{C}$                     | 1.2            | 1.56           | 1.8  | V             |
|           | Reverse Current                             | $I_R$        | $V_R = 3 \text{ V}$ , $T_A = 25^\circ\text{C}$                       |                |                | 10   | $\mu\text{A}$ |
|           | Input Capacitance                           | $C_{IN}$     | $f = 1 \text{ MHz}$ , $V_F = 0 \text{ V}$ , $T_A = 25^\circ\text{C}$ |                | 30             |      | pF            |
| Detector  | High Level Output Current                   | $I_{OH}$     | $V_O = (V_{CC} - 4 \text{ V})^{*2}$                                  | 0.5            | 2.0            |      | A             |
|           |                                             |              | $V_O = (V_{CC} - 15 \text{ V})^{*3}$                                 | 2.0            |                |      |               |
|           | Low Level Output Current                    | $I_{OL}$     | $V_O = (V_{EE} + 2.5 \text{ V})^{*2}$                                | 0.5            | 2.0            |      | A             |
|           |                                             |              | $V_O = (V_{EE} + 15 \text{ V})^{*3}$                                 | 2.0            |                |      |               |
|           | High Level Output Voltage                   | $V_{OH}$     | $I_O = -100 \text{ mA}^{*4}$                                         | $V_{CC} - 3.0$ | $V_{CC} - 1.5$ |      | V             |
|           | Low Level Output Voltage                    | $V_{OL}$     | $I_O = 100 \text{ mA}$                                               |                | 0.1            | 0.5  | V             |
|           | High Level Supply Current                   | $I_{CCH}$    | $V_O = \text{open}$ , $I_F = 10 \text{ mA}$                          |                | 1.4            | 3.0  | mA            |
|           | Low Level Supply Current                    | $I_{CCL}$    | $V_O = \text{open}$ , $V_F = 0 \text{ to } +0.8 \text{ V}$           |                | 1.3            | 3.0  | mA            |
|           | UVLO Threshold                              | $V_{UVLO+}$  | $V_O > 5 \text{ V}$ , $I_F = 10 \text{ mA}$                          | 10.8           | 12.3           | 13.4 | V             |
|           |                                             | $V_{UVLO-}$  |                                                                      | 9.5            | 11.0           | 12.5 |               |
|           | UVLO Hysteresis                             | $UVLO_{HYS}$ | $V_O > 5 \text{ V}$ , $I_F = 10 \text{ mA}$                          | 0.4            | 1.3            |      | V             |
| Coupled   | Threshold Input Current (L $\rightarrow$ H) | $I_{FLH}$    | $I_O = 0 \text{ mA}$ , $V_O > 5 \text{ V}$                           |                | 2.0            | 5.0  | mA            |
|           | Threshold Input Voltage (H $\rightarrow$ L) | $V_{FHL}$    | $I_O = 0 \text{ mA}$ , $V_O < 5 \text{ V}$                           | 0.8            |                |      | V             |

\*1 Typical values at  $T_A = 25^\circ\text{C}$ .\*2 Maximum pulse width = 50  $\mu\text{s}$ , Maximum duty cycle = 0.5%.\*3 Maximum pulse width = 10  $\mu\text{s}$ , Maximum duty cycle = 0.2%\*4  $V_{OH}$  is measured with the DC load current in this testing (Maximum pulse width = 2 ms, Maximum duty cycle = 20%).

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**SWITCHING CHARACTERISTICS****(V<sub>EE</sub> = GND, unless otherwise specified and refer to RECOMMENDED OPERATING CONDITIONS)**

| Parameter                                                    | Symbol                              | Conditions                                                                                                                             | MIN. | TYP.* <sup>1</sup> | MAX. | Unit  |
|--------------------------------------------------------------|-------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------|------|--------------------|------|-------|
| Propagation Delay Time (L → H)                               | t <sub>PLH</sub>                    | R <sub>g</sub> = 10 Ω, C <sub>g</sub> = 10 nF, f = 10 kHz,<br>Duty Cycle = 50%* <sup>2</sup> , I <sub>F</sub> = 10 mA                  |      | 0.07               | 0.25 | μs    |
| Propagation Delay Time (H → L)                               | t <sub>PHL</sub>                    |                                                                                                                                        |      | 0.10               | 0.25 | μs    |
| Pulse Width Distortion (PWD)                                 | t <sub>PHL</sub> - t <sub>PLH</sub> |                                                                                                                                        |      | 0.03               | 0.1  | μs    |
| Propagation Delay Time (Difference Between Any Two Products) | t <sub>PHL</sub> - t <sub>PLH</sub> |                                                                                                                                        | -0.1 |                    | 0.1  | μs    |
| Rise Time                                                    | t <sub>r</sub>                      |                                                                                                                                        |      | 50                 |      | ns    |
| Fall Time                                                    | t <sub>f</sub>                      |                                                                                                                                        |      | 50                 |      | ns    |
| UVLO (Turn On Delay)                                         | t <sub>UVLO ON</sub>                | V <sub>O</sub> > 5 V, I <sub>F</sub> = 10 mA                                                                                           |      | 0.8                |      | μs    |
| UVLO (Turn Off Delay)                                        | t <sub>UVLO OFF</sub>               | V <sub>O</sub> < 5 V, I <sub>F</sub> = 10 mA                                                                                           |      | 0.6                |      | μs    |
| Common Mode Transient Immunity at High Level Output          | CM <sub>H</sub>                     | T <sub>A</sub> = 25°C, I <sub>F</sub> = 10 to 16 mA, V <sub>CC</sub> = 30 V,<br>V <sub>O (MIN.)</sub> = 26 V, V <sub>CM</sub> = 1.5 kV | 25   |                    |      | kV/μs |
| Common Mode Transient Immunity at Low Level Output           | CM <sub>L</sub>                     | T <sub>A</sub> = 25°C, I <sub>F</sub> = 0 mA, V <sub>CC</sub> = 30 V,<br>V <sub>O (MAX.)</sub> = 1 V, V <sub>CM</sub> = 1.5 kV         | 25   |                    |      | kV/μs |

\*1 Typical values at T<sub>A</sub> = 25°C.

\*2 This load condition is equivalent to the IGBT load at 1 200 V/75 A.

## TEST CIRCUIT

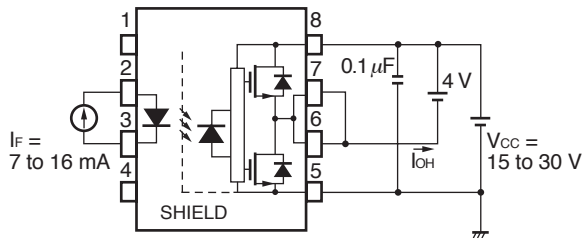
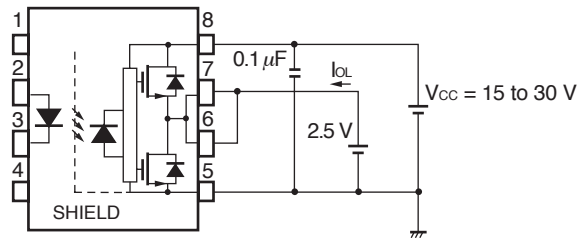
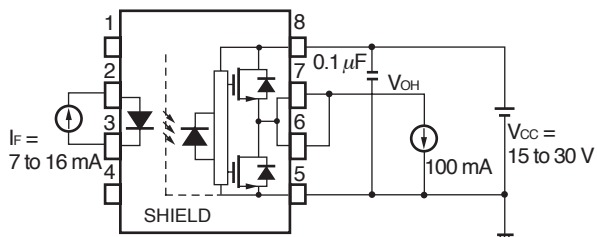
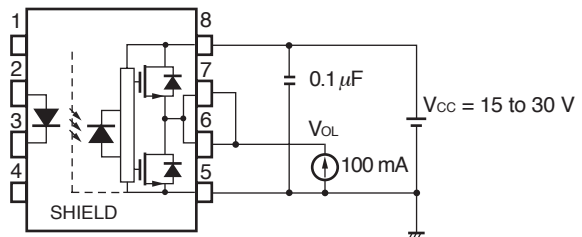
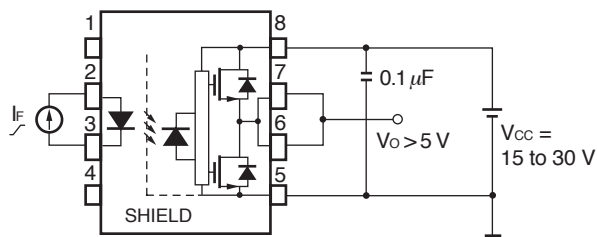
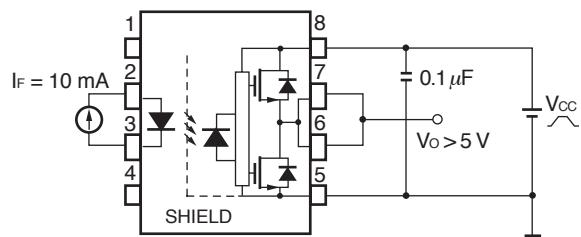
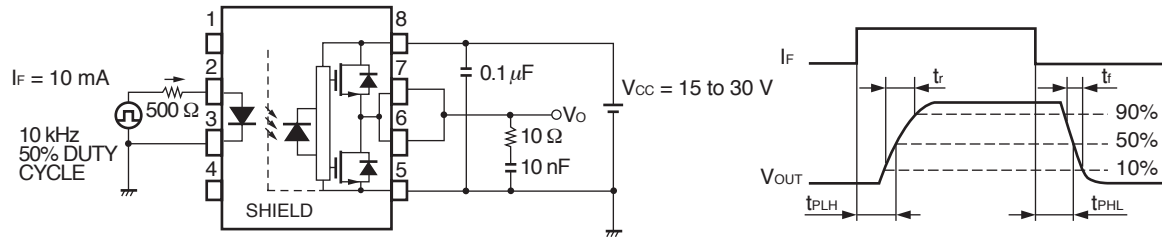
Fig. 1  $I_{OH}$  Test CircuitFig. 2  $I_{OL}$  Test CircuitFig. 3  $V_{OH}$  Test CircuitFig. 4  $V_{OL}$  Test CircuitFig. 5  $I_{FLH}$  Test Circuit

Fig. 6 UVLO Test Circuit

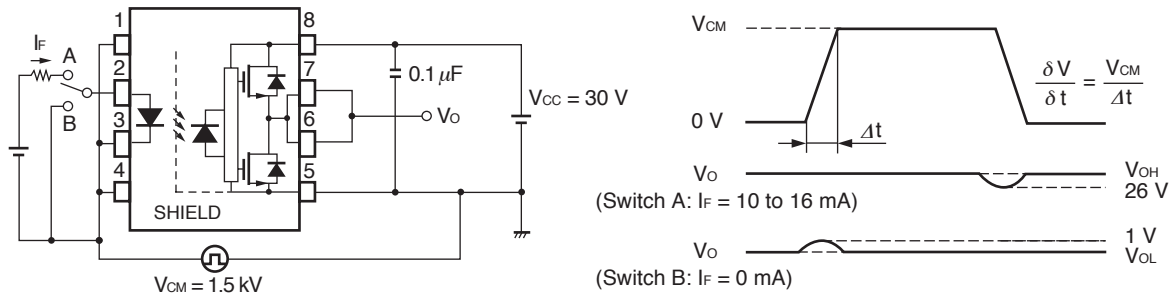


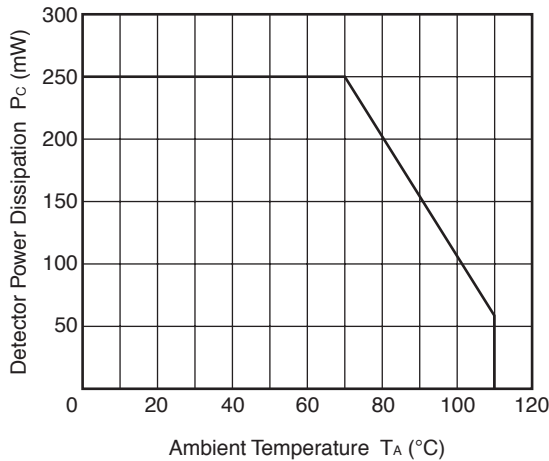
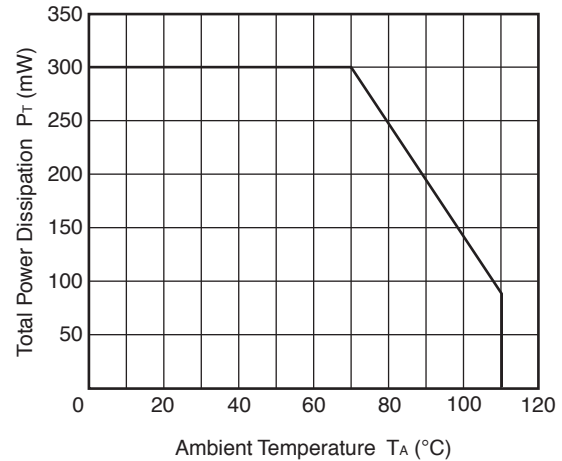
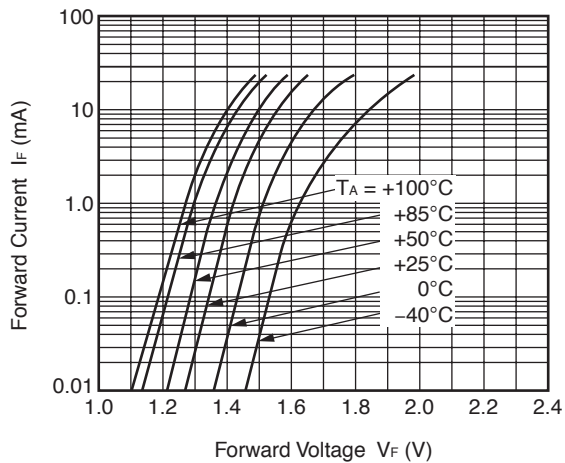
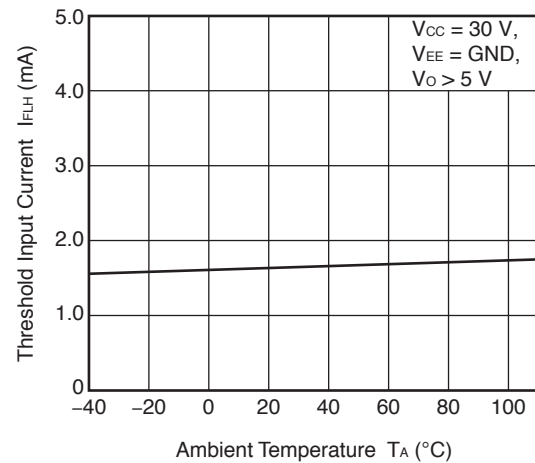
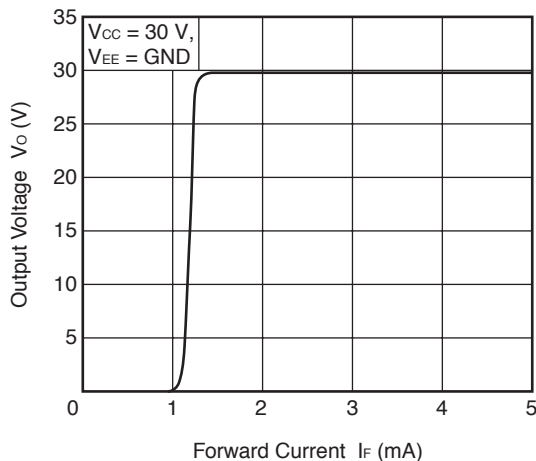
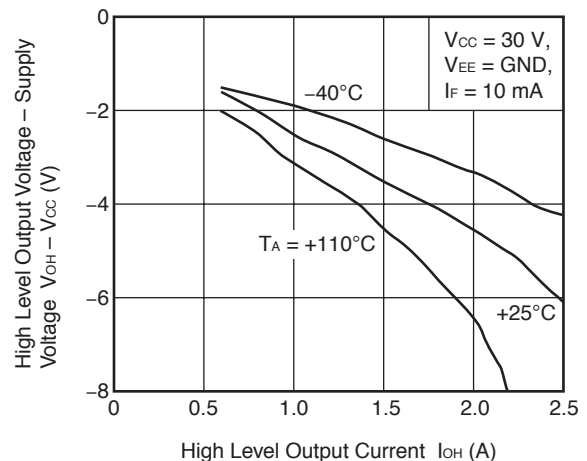
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Fig. 7  $t_{PLH}$ ,  $t_{PHL}$ ,  $t_r$ ,  $t_f$  Test Circuit and Wave Forms

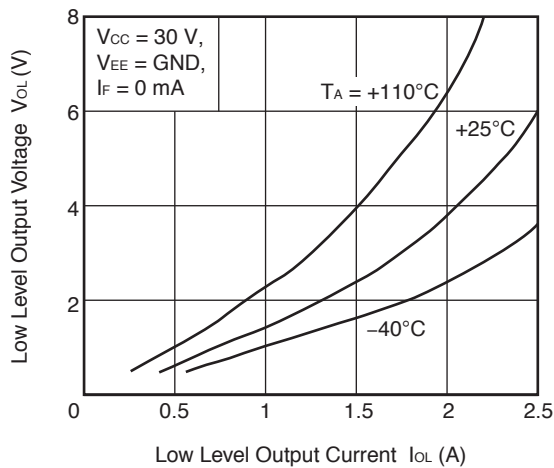
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Fig. 8 CMR Test Circuit and Wave Forms

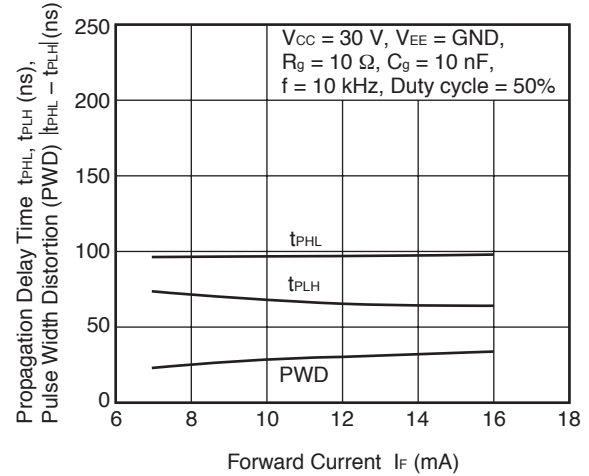


<R> **TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise specified)****DETECTOR POWER DISSIPATION  
vs. AMBIENT TEMPERATURE****TOTAL POWER DISSIPATION  
vs. AMBIENT TEMPERATURE****FORWARD CURRENT vs.  
FORWARD VOLTAGE****THRESHOLD INPUT CURRENT vs.  
AMBIENT TEMPERATURE****OUTPUT VOLTAGE vs.  
FORWARD CURRENT****HIGH LEVEL OUTPUT VOLTAGE – SUPPLY  
VOLTAGE vs. HIGH LEVEL OUTPUT CURRENT****Remark** The graphs indicate nominal characteristics.

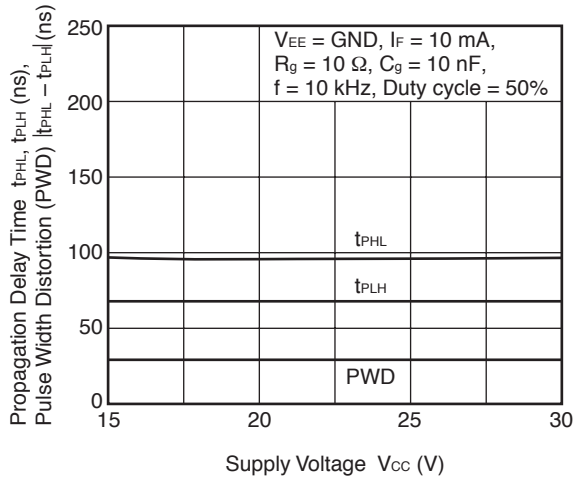
LOW LEVEL OUTPUT VOLTAGE vs.  
LOW LEVEL OUTPUT CURRENT



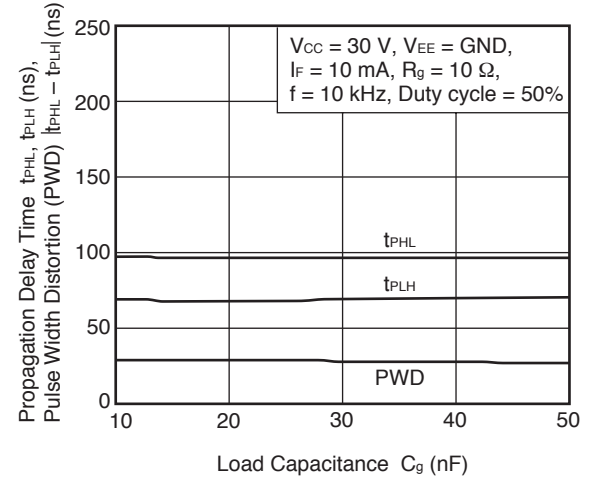
PROPAGATION DELAY TIME,  
PULSE WIDTH DISTORTION  
vs. FORWARD CURRENT



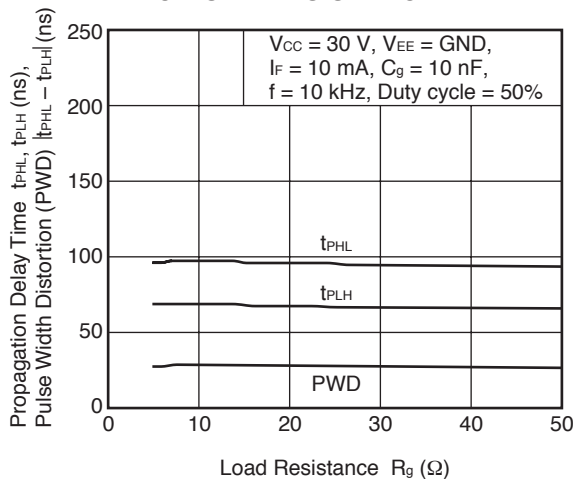
PROPAGATION DELAY TIME,  
PULSE WIDTH DISTORTION  
vs. SUPPLY VOLTAGE



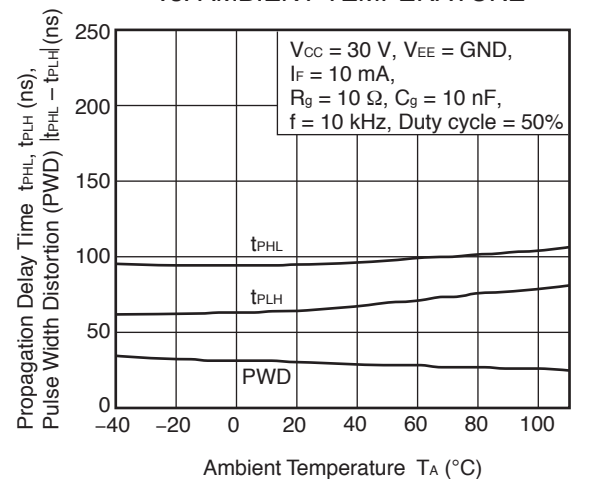
PROPAGATION DELAY TIME,  
PULSE WIDTH DISTORTION  
vs. LOAD CAPACITANCE



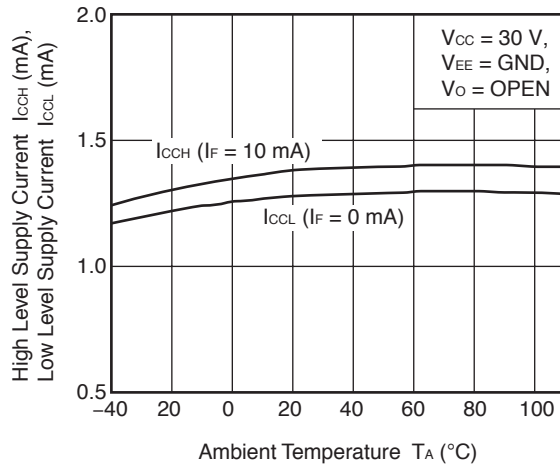
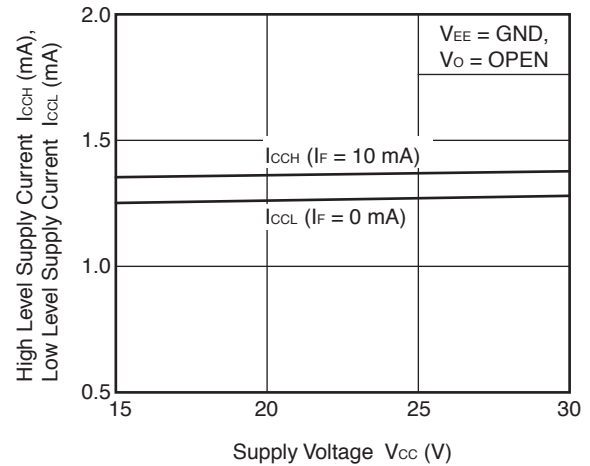
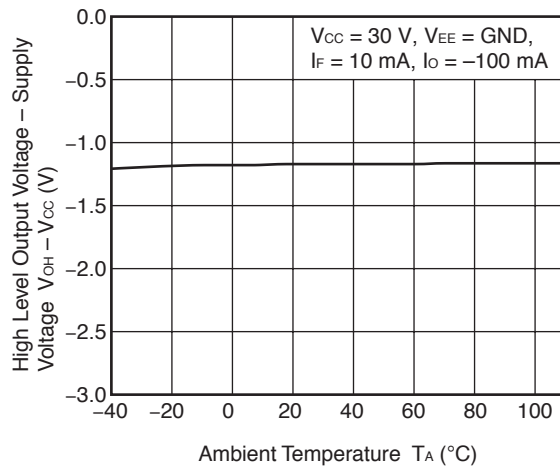
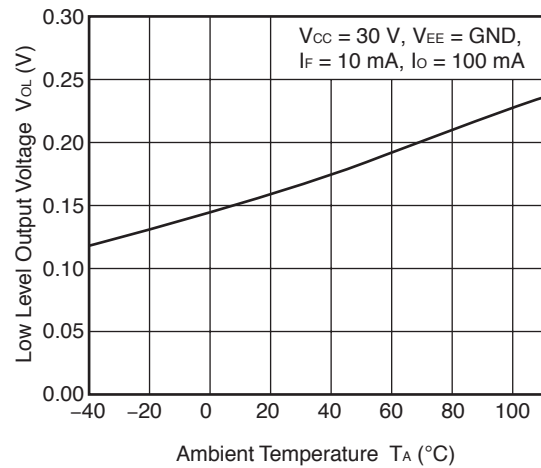
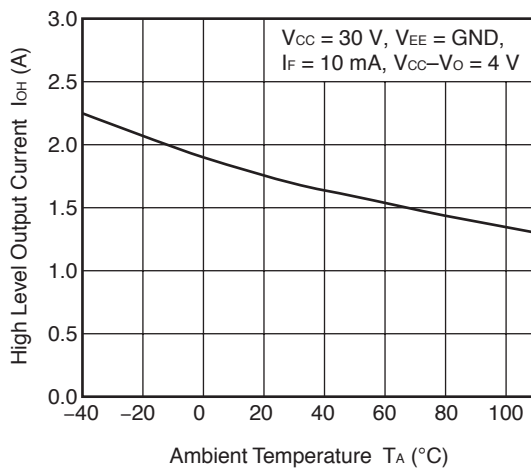
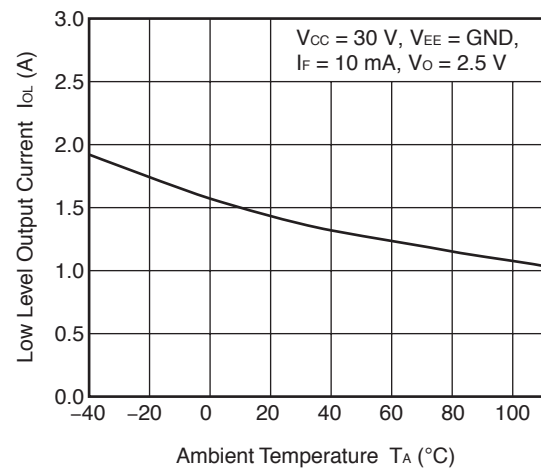
PROPAGATION DELAY TIME,  
PULSE WIDTH DISTORTION  
vs. LOAD RESISTANCE



PROPAGATION DELAY TIME,  
PULSE WIDTH DISTORTION  
vs. AMBIENT TEMPERATURE

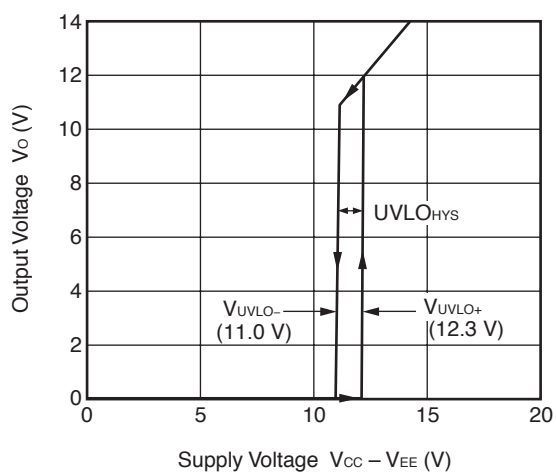


**Remark** The graphs indicate nominal characteristics.

SUPPLY CURRENT vs.  
AMBIENT TEMPERATURESUPPLY CURRENT vs.  
SUPPLY VOLTAGEHIGH LEVEL OUTPUT VOLTAGE – SUPPLY  
VOLTAGE vs. AMBIENT TEMPERATURELOW LEVEL OUTPUT VOLTAGE vs.  
AMBIENT TEMPERATUREHIGH LEVEL OUTPUT CURRENT vs.  
AMBIENT TEMPERATURELOW LEVEL OUTPUT CURRENT vs.  
AMBIENT TEMPERATURE

**Remark** The graphs indicate nominal characteristics.

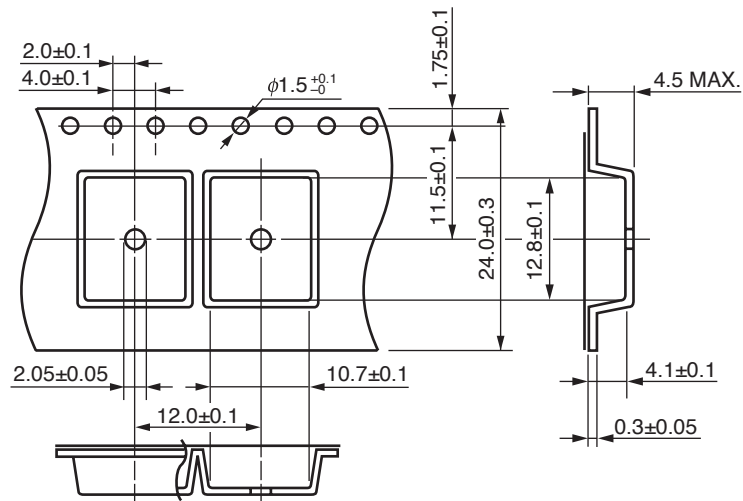
OUTPUT VOLTAGE vs. SUPPLY VOLTAGE



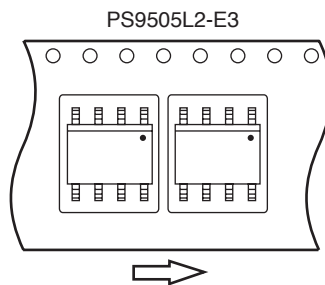
**Remark** The graph indicates nominal characteristics.

## TAPING SPECIFICATIONS (UNIT: mm)

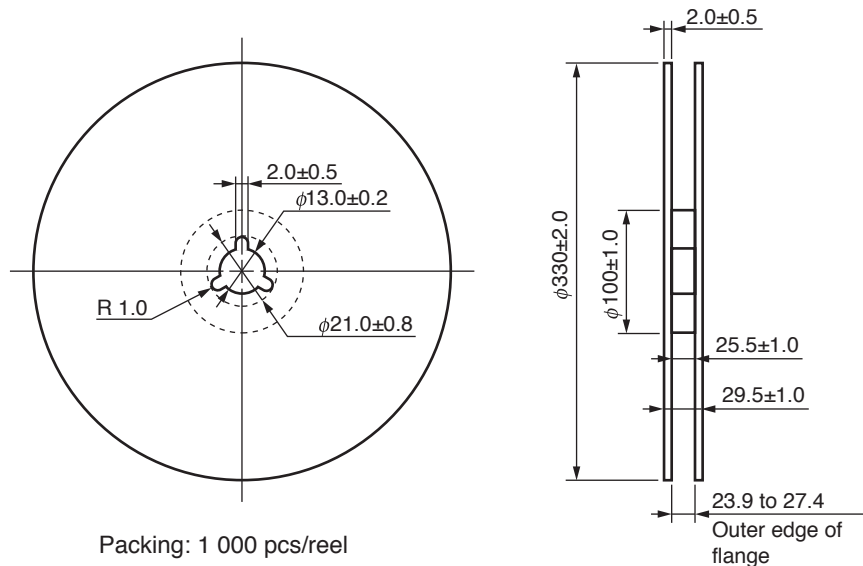
## Outline and Dimensions (Tape)



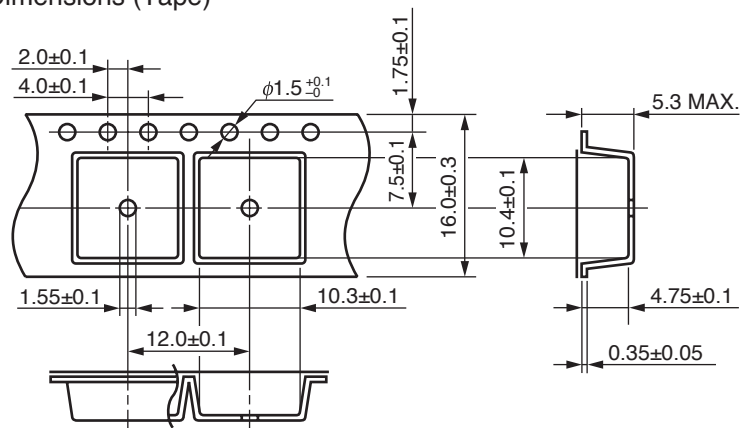
## Tape Direction



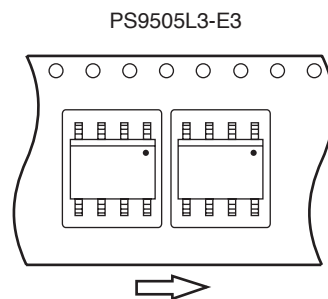
## Outline and Dimensions (Reel)



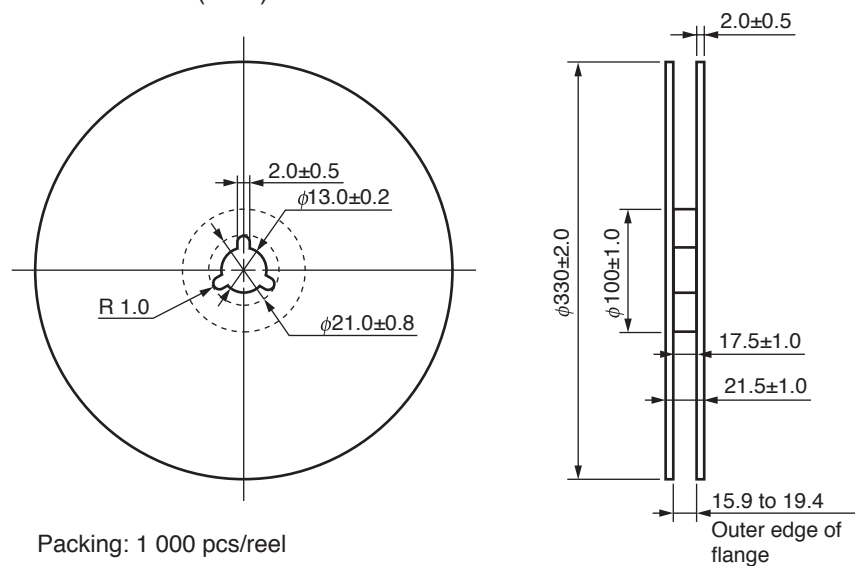
## Outline and Dimensions (Tape)



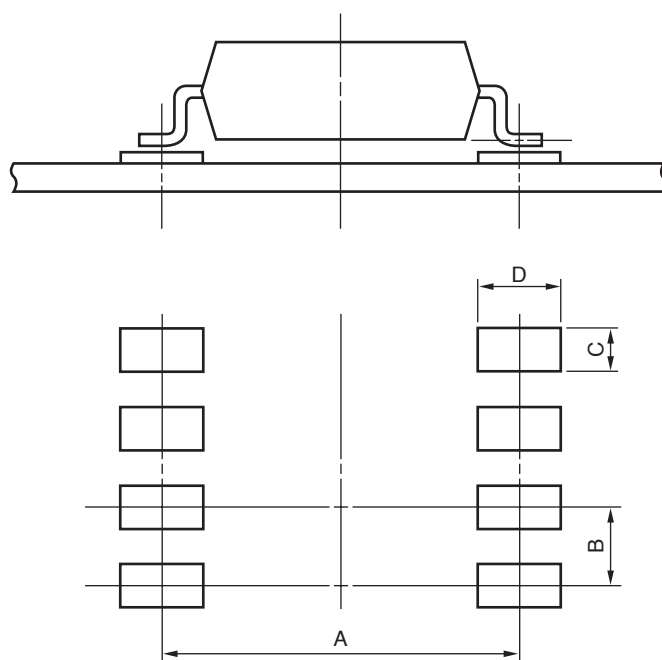
## Tape Direction



## Outline and Dimensions (Reel)



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**RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)**

| Part Number | Lead Bending                                                                | A    | B    | C   | D   |
|-------------|-----------------------------------------------------------------------------|------|------|-----|-----|
| PS9505L2    | lead bending type (Gull-wing)<br>for long creepage distance (surface mount) | 10.2 | 2.54 | 1.7 | 2.2 |
| PS9505L3    | lead bending type (Gull-wing)<br>for surface mount                          | 9.0  | 2.54 | 1.7 | 2.0 |

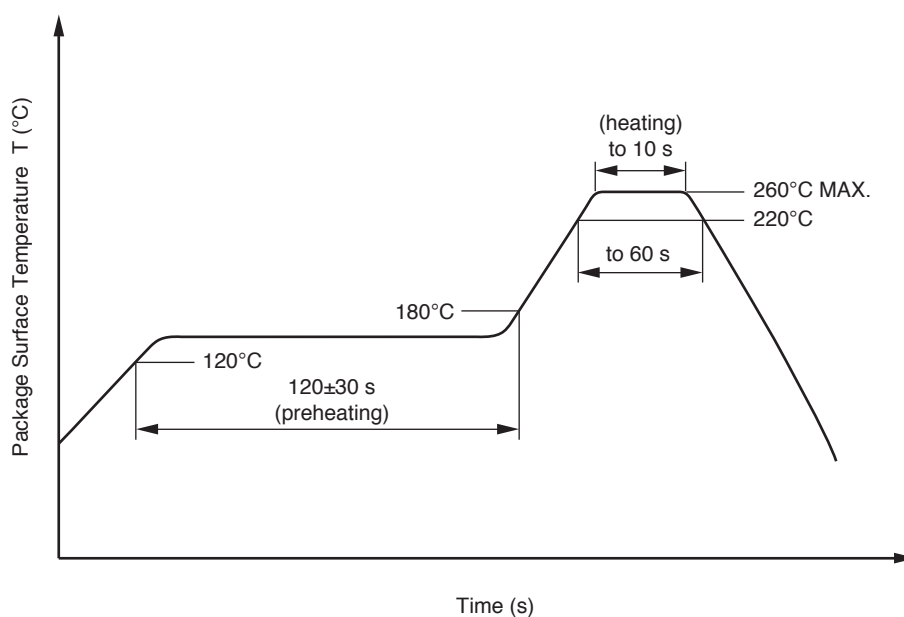
## NOTES ON HANDLING

### 1. Recommended soldering conditions

#### (1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

**(4) Cautions**

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

**2. Cautions regarding noise**

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

**USAGE CAUTIONS**

1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.

2. Board designing

- (1) By-pass capacitor of more than 0.1  $\mu$ F is used between  $V_{CC}$  and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.

- (2) When designing the printed wiring board, ensure that the pattern of the IGBT collectors/emitters is not too close to the input block pattern of the photocoupler.

If the pattern is too close to the input block and coupling occurs, a sudden fluctuation in the voltage on the IGBT output side might affect the photocoupler's LED input, leading to malfunction or degradation of characteristics.

(If the pattern needs to be close to the input block, to prevent the LED from lighting during the off state due to the abovementioned coupling, design the input-side circuit so that the bias of the LED is reversed, within the range of the recommended operating conditions, and be sure to thoroughly evaluate operation.)

- (3) Pins 1, 4 (which is an NC<sup>\*1</sup> pin) can either be connected directly to the GND pin on the LED side or left open.

Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.

<sup>\*1</sup> NC: Non-Connection (No Connection)

3. Make sure the rise/fall time of the forward current is 0.5  $\mu$ s or less.
4. In order to avoid malfunctions, make sure the rise/fall slope of the supply voltage is 3 V/ $\mu$ s or less.
5. Avoid storage at a high temperature and high humidity.

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**SPECIFICATION OF VDE MARKS LICENSE DOCUMENT**

| Parameter                                                                                                                                                | Symbol                         | Spec.                  | Unit                 |
|----------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|------------------------|----------------------|
| Climatic test class (IEC 60068-1/DIN EN 60068-1)                                                                                                         |                                | 40/110/21              |                      |
| Dielectric strength                                                                                                                                      |                                |                        |                      |
| maximum operating isolation voltage                                                                                                                      | $U_{IORM}$                     | 1 130                  | $V_{peak}$           |
| Test voltage (partial discharge test, procedure a for type test and random test)<br>$U_{pr} = 1.6 \times U_{IORM}$ , $P_d < 5$ pC                        | $U_{pr}$                       | 1 808                  | $V_{peak}$           |
| Test voltage (partial discharge test, procedure b for all devices)<br>$U_{pr} = 1.875 \times U_{IORM}$ , $P_d < 5$ pC                                    | $U_{pr}$                       | 2 119                  | $V_{peak}$           |
| Highest permissible overvoltage                                                                                                                          | $U_{TR}$                       | 8 000                  | $V_{peak}$           |
| Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)                                                                                                      |                                | 2                      |                      |
| Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))                                                                                   | CTI                            | 175                    |                      |
| Material group (DIN EN 60664-1 VDE0110 Part 1)                                                                                                           |                                | III a                  |                      |
| Storage temperature range                                                                                                                                | $T_{stg}$                      | −55 to +125            | °C                   |
| Operating temperature range                                                                                                                              | $T_A$                          | −40 to +110            | °C                   |
| Isolation resistance, minimum value<br>$V_{IO} = 500$ V dc at $T_A = 25^\circ\text{C}$<br>$V_{IO} = 500$ V dc at $T_A$ MAX. at least $100^\circ\text{C}$ | $R_{is}$ MIN.<br>$R_{is}$ MIN. | $10^{12}$<br>$10^{11}$ | $\Omega$<br>$\Omega$ |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve)                                                                |                                |                        |                      |
| Package temperature                                                                                                                                      | $T_{si}$                       | 175                    | °C                   |
| Current (input current $I_F$ , $P_{si} = 0$ )                                                                                                            | $I_{si}$                       | 400                    | mA                   |
| Power (output or total power dissipation)                                                                                                                | $P_{si}$                       | 700                    | mW                   |
| Isolation resistance<br>$V_{IO} = 500$ V dc at $T_A = T_{si}$                                                                                            | $R_{is}$ MIN.                  | $10^9$                 | $\Omega$             |

**Caution**

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
  2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

|                         |                                                     |
|-------------------------|-----------------------------------------------------|
| <b>Revision History</b> | <b>PS9505,PS9505L1,PS9505L2,PS9505L3 Data Sheet</b> |
|-------------------------|-----------------------------------------------------|

| Rev. | Date         | Description |                                                                |
|------|--------------|-------------|----------------------------------------------------------------|
|      |              | Page        | Summary                                                        |
| 0.01 | May 12, 2010 | –           | First Edition issued                                           |
| 1.00 | Jan 06, 2012 | Throughout  | Preliminary Data Sheet -> Data Sheet                           |
|      |              | Throughout  | Safety standards approved                                      |
|      |              | p.1         | Addition of Pb-Free product                                    |
|      |              | p.4         | Modification of <b>MARKING EXAMPLE</b>                         |
|      |              | p.5         | Addition of <b>ORDERING INFORMATION</b>                        |
|      |              | p.6         | Modification of <b>ELECTRICAL CHARACTERISTICS</b>              |
|      |              | p.7         | Modification of <b>SWITCHING CHARACTERISTICS</b>               |
|      |              | p.9         | Modification of <b>TEST CIRCUIT</b>                            |
|      |              | pp.10 to 13 | Addition of <b>TYPICAL CHARACTERISTICS</b>                     |
|      |              | p.16        | Modification of <b>RECOMMENDED MOUNT PAD DIMENSIONS</b>        |
|      |              | p.18        | Modification of <b>USAGE CAUTIONS 2. (2)</b>                   |
|      |              | p.19        | Addition of <b>SPECIFICATION OF VDE MARKS LICENSE DOCUMENT</b> |

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